

EP3SE260F1152C3

EP3SE260F1152C3 Information

www.bergener.com	Part Number Manufacturer Category	EP3SE260F1152C3 Intel Integrated Circuits (ICs) Embedded - FPGAs (Field Programmable Gate Array)	
	Description	IC FPGA 744 I/O 1152FBGA	1.200
	Package	1152-BBGA, FCBGA	
For Reference Only		For the pricing/inventory/lead time, please contact	
		Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



EP3SE260F1152C3 Specifications

Manufacturer Part Number	EP3SE260F1152C3
Manufacturer	Intel
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	1152-BBGA, FCBGA
Series	Stratix® III E
Number of LABs/CLBs	10200
Number of Logic Elements/Cells	255000
Total RAM Bits	16672768
Number of I/O	744
Number of Gates	-
Voltage - Supply	0.86 V ~ 1.15 V
Mounting Type	Surface Mount
Operating Temperature	0° C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FBGA (35x35)
	Report errors?

EP3SE260F1152C3 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

EP3SE260F1152C3 Payment Methods



EP3SE260F1152C3 Shipping Methods



If you have any question about EP3SE260F1152C3, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com